2-input EXCLUSIVE-OR gate Rev. 05 — 4 July 2007

#### **General description** 1.

74AHC1G86 and 74AHCT1G86 are high-speed Si-gate CMOS devices. They provide a 2-input EXCLUSIVE-OR function.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

#### 2. **Features**

- Symmetrical output impedance
- High noise immunity
- ESD protection:
  - HBM JESD22-A114E: exceeds 2000 V
  - MM JESD22-A115-A: exceeds 200 V
  - CDM JESD22-C101C: exceeds 1000 V
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options
- Specified from –40 °C to +125 °C

### 3. Ordering information

Table 1.	Ordering information
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Type number	Package									
	Temperature range	Name	Description	Version						
74AHC1G86GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads;	SOT353-1						
74AHCT1G86GW			body width 1.25 mm							
74AHC1G86GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753						
74AHCT1G86GV	_									

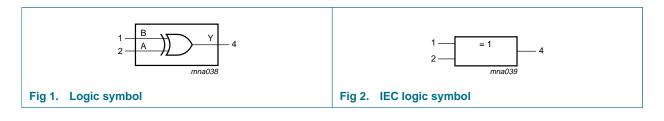


2-input EXCLUSIVE-OR gate

### 4. Marking

Table 2.   Marking codes	
Type number	Marking code
74AHC1G86GW	АН
74AHCT1G86GW	СН
74AHC1G86GV	A86
74AHCT1G86GV	C86

## 5. Functional diagram



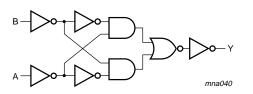
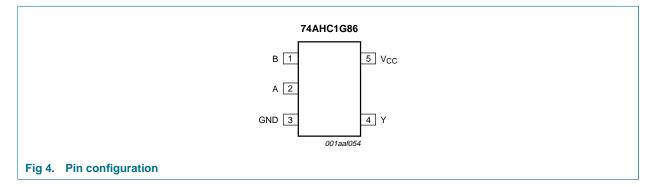


Fig 3. Logic diagram

## 6. Pinning information

## 6.1 Pinning



### 6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
А	2	data input
GND	3	ground (0 V)
Y	4	data output
V <sub>CC</sub>	5	supply voltage

## 7. Functional description

#### Table 4.Function table

*H* = *HIGH* voltage level; *L* = *LOW* voltage level

Inputs	Output	
Α	В	Y
L	L	L
L	Н	Н
Н	L	Н
н	Н	L

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>O</sub>	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I <sub>CC</sub>	supply current		-	75	mA
I <sub>GND</sub>	ground current		-75	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

2-input EXCLUSIVE-OR gate

## 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74	AHC1G	86	74AHCT1G86			Unit	
			Min	Тур	Max	Min	Тур	Max	V V V V °C ns/V	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V	
VI	input voltage		0	-	5.5	0	-	5.5	V	
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	$V_{CC}$	V	
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C	
$\Delta t / \Delta V$	input transition rise	$V_{CC}=3.3~V\pm0.3~V$	-	-	100	-	-	-	ns/V	
	and fall rate	$V_{CC}=5.0~V\pm0.5~V$	-	-	20	-	-	20	ns/V	

## **10. Static characteristics**

#### Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		<b>−40</b> °C	to +85 °C	–40 °C to +125 °C Un		Uni
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G86									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
VIL	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
	V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V	
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -50 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_0 = -50 \ \mu A; \ V_{CC} = 3.0 \ V$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V	-	-	0.36	-	0.44	-	0.55	V V V V V V V V V V V V V V V V V V V
I	input leakage current	$V_{I} = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
сс	supply current		-	-	1.0	-	10	-	40	μA
Cı	input capacitance		-	1.5	10	-	10	-	10	рF

74AHC\_AHCT1G86\_5

Product data sheet

2-input EXCLUSIVE-OR gate

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	<b>−40</b> °C t	o +125 °C	Unit
		Min	Тур	Max	Min	Max	Min	Min Max	1	
For type	74AHCT1G86									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
outpu	output voltage	I <sub>O</sub> = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.8	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
l <sub>l</sub>	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current		-	-	1.0	-	10	-	40	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; V <sub>I</sub> = 3.4 V; other inputs at V <sub>CC</sub> or GND; $I_O = 0 A$ ; V <sub>CC</sub> = 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	1.5	10	-	10	-	10	pF

### Table 7. Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V).

## **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For waveform see Figure 5. For test circuit see Figure 6.

			<u> </u>								
Symbol	Parameter	Conditions			25 °C		<b>−40</b> °C 1	to +85 °C	<b>−40 °C to +125 °C</b>		Unit
				Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC1G86										
t <sub>pd</sub> propagatio delay	propagation	A and B to Y	<u>[1]</u>								
	delay	$V_{CC}$ = 3.0 V to 3.6 V	[2]								
		C <sub>L</sub> = 15 pF		-	4.0	11.0	1.0	13.0	1.0	14.0	ns
		C <sub>L</sub> = 50 pF		-	5.8	14.5	1.0	16.5	1.0	18.5	ns
		$V_{CC}$ = 4.5 V to 5.5 V	[3]								
		C <sub>L</sub> = 15 pF		-	3.4	6.8	1.0	8.0	1.0	8.5	ns
		C <sub>L</sub> = 50 pF		-	4.9	8.8	1.0	10.0	1.0	11.5	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	[4]	-	9	-	-	-	-	-	pF

74AHC\_AHCT1G86\_5

2-input EXCLUSIVE-OR gate

Symbol	Parameter	Conditions			25 °C		<b>−40</b> °C	to +85 °C	–40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	9.0	
For type	74AHCT1G8	6									
pa i	propagation	A and B to Y	<u>[1]</u>								
	delay	$V_{CC}$ = 4.5 V to 5.5 V	[3]								
		C <sub>L</sub> = 15 pF		-	3.5	6.9	1.0	8.0	1.0	9.0	ns
		C <sub>L</sub> = 50 pF		-	5.0	7.9	1.0	9.0	1.0	10.5	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	[4]	-	11	-	-	-	-	-	pF

#### Table 8. Dynamic characteristics ...continued

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For waveform see Figure 5. For test circuit see Figure 6.

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] Typical values are measured at V<sub>CC</sub> = 3.3 V.

[3] Typical values are measured at  $V_{CC} = 5.0$  V.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

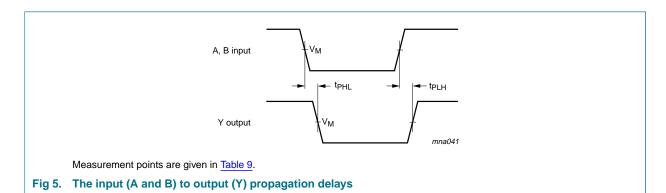
 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts.

### 12. Waveforms



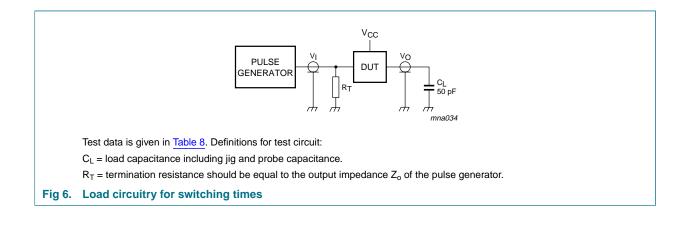
#### Table 9. Measurement points

Туре	Input	Output	
	VI	V <sub>M</sub>	V <sub>M</sub>
74AHC1G86	GND to V <sub>CC</sub>	$0.5  imes V_{CC}$	$0.5 \times V_{CC}$
74AHCT1G86	GND to 3.0 V	1.5 V	$0.5 \times V_{CC}$

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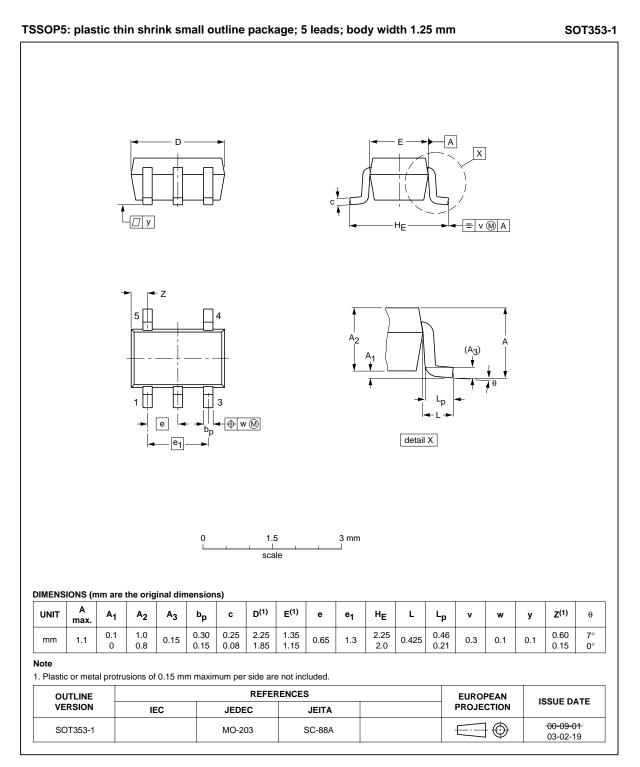
## 74AHC1G86; 74AHCT1G86

2-input EXCLUSIVE-OR gate



2-input EXCLUSIVE-OR gate

## 13. Package outline



#### Fig 7. Package outline SOT353-1 (TSSOP5)

74AHC\_AHCT1G86\_5

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2-input EXCLUSIVE-OR gate

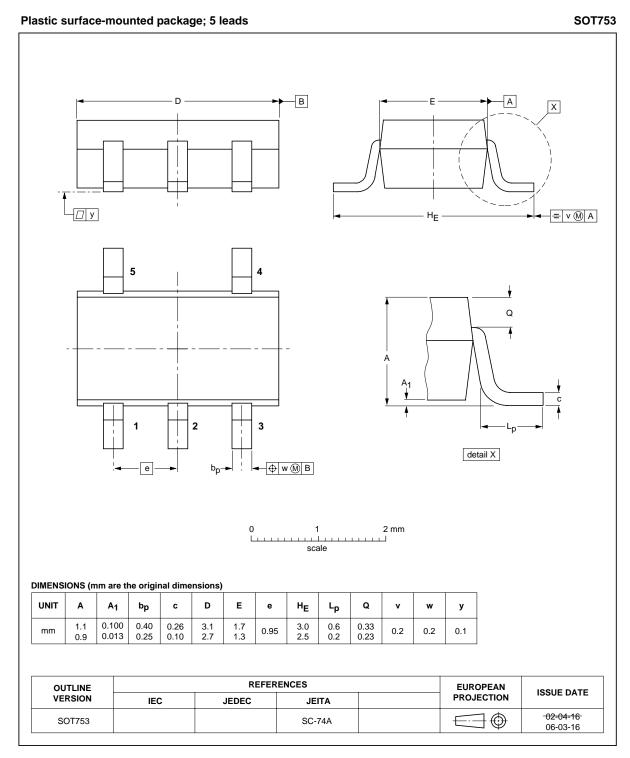


Fig 8. Package outline SOT753 (SC-74A)

74AHC\_AHCT1G86\_5

Product data sheet

2-input EXCLUSIVE-OR gate

## 14. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

## 15. Revision history

Table 11. Revision histo	ory				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AHC_AHCT1G86_5	20070704	Product data sheet	-	74AHC_AHCT1G86_4	
Modifications:		f this data sheet has been rede NXP Semiconductors.	esigned to comply w	ith the new identity	
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
	<ul> <li>Package SOT353 changed to SOT353-1 in Section 3 and Section 13.</li> </ul>				
	<ul> <li>Quick reference</li> </ul>	nce data and Soldering section	s removed.		
74AHC_AHCT1G86_4	20020606	Product specification	-	74AHC_AHCT1G86_3	
74AHC_AHCT1G86_3	20020218	Product specification	-	74AHC_AHCT1G86_2	
74AHC_AHCT1G86_2	20010406	Product specification	-	74AHC1G_AHCT1G86_	
74AHC1G_AHCT1G86_1	19990920	Product specification	-	-	

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### 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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2-input EXCLUSIVE-OR gate

### **18. Contents**

1	General description 1
2	Features 1
3	Ordering information 1
4	Marking 2
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 3
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 4
10	Static characteristics 4
11	Dynamic characteristics 5
12	Waveforms 6
13	Package outline
14	Abbreviations
15	Revision history 10
16	Legal information
16.1	Data sheet status 11
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks 11
17	Contact information 11
18	Contents 12



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